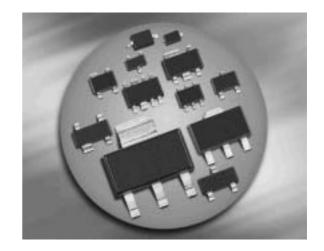


High Voltage Schottky Diode

- Rectifier Schottky diode for telecommunication and industrial applications
- High reverse voltage: 240 V
- For power supply applications
- For clamping and protection in high voltage applications
- Pb-free (RoHS compliant) package 1)
- Qualified according AEC Q101





BAT240A



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Package	Configuration	Marking
BAT240A	SOT23	half bridge	4Ms

Maximum Ratings at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Diode reverse voltage ²⁾	V _R	240	V
Forward current ²⁾	I _F	400	mA
Non-repetitive peak surge forward current	/ _{FSM}	1	А
(<i>t</i> ≤ 10ms)			
Total power dissipation	P _{tot}	400	mW
<i>T</i> _S ≤ 28°C			
Junction temperature	T _i	150	°C
Operating temperature range	Top	-55 125	
Storage temperature	T _{sta}	-55 150	

¹Pb-containing package may be available upon special request

1

²For TA > 25 °C the derating of VR and IF has to be considered. Please refer to the attached curves.



Th	erm	al	Res	istai	nce
		uı	1103	Julian	

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	≤ 305	K/W

Electrical Characteristics at T_{Λ} = 25°C, unless otherwise specified

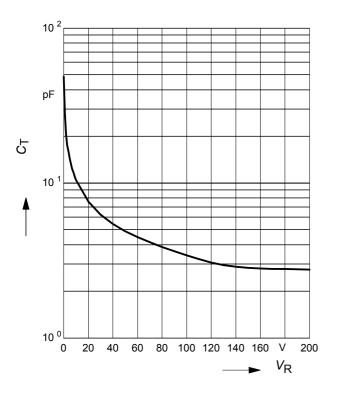
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics			1		•
Breakdown voltage	$V_{(BR)}$	240	_	-	V
I _(BR) = 500 μA					
Reverse current	I _R				μΑ
<i>V</i> _R = 100 V		-	1	10	
V _R = 200 V		-	5	-	
Forward voltage	V _F				V
I _F = 10 mA		0.25	0.325	0.36	
$I_{\rm F}$ = 20 mA		0.29	0.37	0.41	
$I_{\rm F}$ = 50 mA		0.35	0.47	0.52	
I _F = 100 mA		-	0.58	-	
I _F = 200 mA		-	0.72	-	
$I_{\rm F}$ = 400 mA		-	0.9	-	
AC Characteristics					
Diode capacitance	C _T				pF
$V_{R} = 10 \text{ V}, f = 1 \text{ MHz}$		-	11	15	
$V_{R} = 5 \text{ V}, f = 1 \text{ MHz}$		_	15	20	

 $^{^{1}\}mbox{For calculation of}\,R_{\mbox{\scriptsize thJA}}$ please refer to Application Note Thermal Resistance



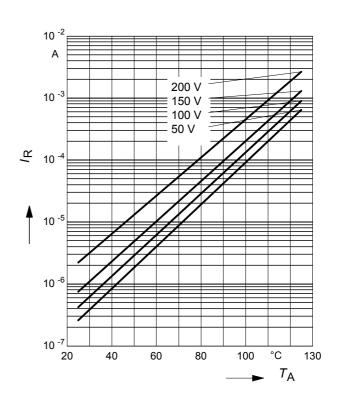
Diode capacitance $C_T = f(V_R)$

f = 1MHz



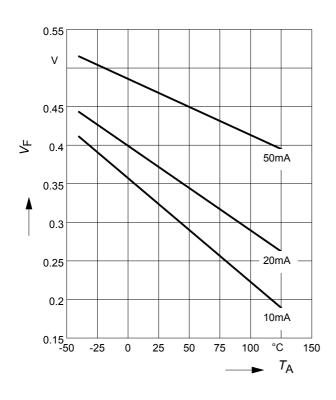
Reverse current $I_R = f(T_A)$

 V_{R} = Parameter



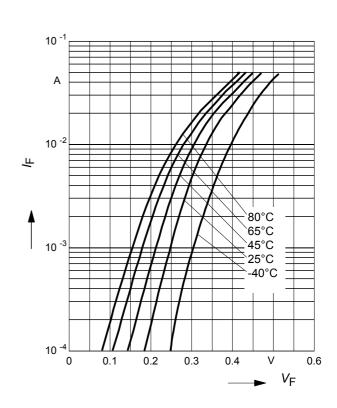
Forward Voltage $V_F = f(T_A)$

 $I_{\rm F}$ = Parameter



Forward current $I_F = f(V_F)$

 T_A = Parameter

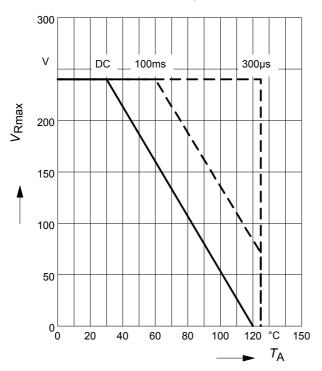




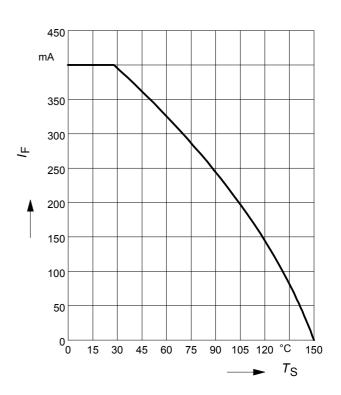
Permissible Reverse voltage $V_R = f(T_A)$

 t_p = Parameter, Duty cycle < 0.01

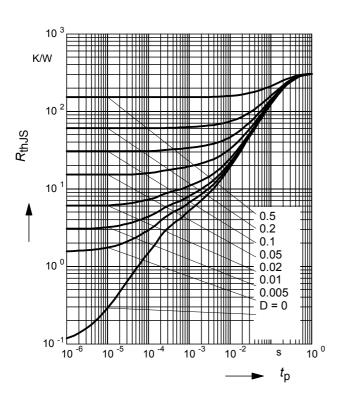
Device mounted on PCB with R_{th} = 160 k/W



Forward current $I_F = f(T_S)$

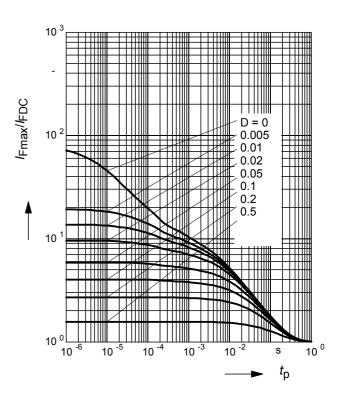


Permissible Puls Load $R_{thJS} = f(t_p)$



Permissible Pulse Load

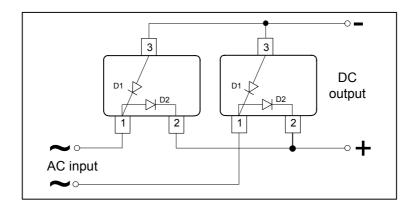
$$I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$$





Application example BAT240A

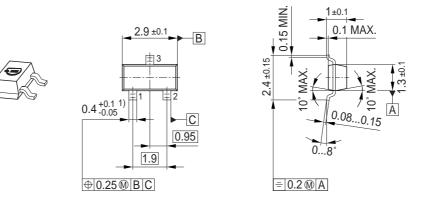
Energy efficient bridge rectification for 110 V / 60 Hz power lines



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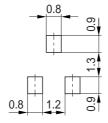


Package Outline

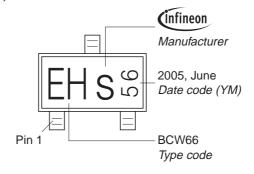


Foot Print



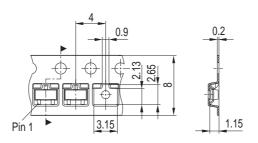


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



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